WAFER HEAD SCREWS



Self-Drill Wafer Head



Sharp Point

Wafer Head

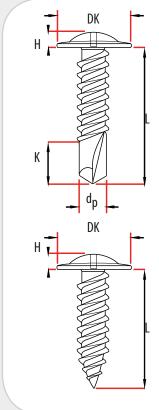
Key Features

Product Information

· Large head Ø for increased clamping.

· For fixing steel to steel applications, particularly metal drylining systems.

- Coarse 60° self tapping thread for extreme grip & excellent pull out.
- Self-drill for steel, with a drilling cappcity between 0.9 - 3.0mm
- · Sharp point for steel, with a max capacity up to 0.8mm
- Phillips N°2 recess for a positive drive.
- Driver bit included
- Full batch traceability.
- BZP finish.



Materials













Self-Drill Wafer Head										
TIMco Code	Size Ø x Length (mm)	Driver Bit Size	Drill Point Size	Max Drill Thickness (mm)	d _p (mm)	L (mm)	DK (mm)	H (mm)	K (mm)	
08916WHSD 00016WHSD 00019WHSD 00025WHSD	4.2 x 13.5 4.2 x 16 4.2 x 19 4.2 x 25	PH2	No. 2	3.0	3.3	13.5 16.0 19.0 25.0	11.0	2.0	4.5	

Sharp Point Wafer Head												
916WHSP	4.2 x 13.5	PH2	N/A	0.8	N/A	13.5	11.0	2.0	N/A			

*all figures stated are approximate and for reference only.